

**INTEGRATED DEVICE PROVIDING CURRENT-REGULATED CHARGE PUMP  
DRIVER WITH CAPACITOR-PROPORTIONAL CURRENT**

Paul W. Latham II

John C. Canfield

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## INTEGRATED DEVICE PROVIDING CURRENT-REGULATED CHARGE PUMP DRIVER WITH CAPACITOR-PROPORTIONAL CURRENT

### 5 BACKGROUND OF THE INVENTION

#### Field of the Invention

10 [0001] The present invention relates to integrated circuit components adapted to surface mount technology. More particularly, the present invention relates to an integrated circuit including a current regulated charge pump wherein the magnitude of the output current is adjusted via scaling of a single external charge pump capacitor.

#### Introduction to the Invention

15 [0002] Battery operated appliances have proliferated throughout the world. Cell phone handsets, portable radios and playback units, personal digital assistants, light emitting diode (LED) flashlights, and wireless security and remote control systems provide only a few of many examples of such appliances. Small batteries of the types commonly employed in these  
20 appliances typically do not put out either constant current or constant voltage. In order for output loads, such as LEDs to be supplied with constant current, feedback regulation techniques are employed. Regulation may be as simple as a ballast resistor or as complex as an integrated circuit with feedback control.

25 [0003] LEDs typically require a supply voltage potential which frequently exceeds the voltage potential supplied by a particular cell or low voltage battery. For example, white LEDs have a forward voltage of 3.5 volts typical, and 4.0 volts maximum, at a current of 20 milliamperes (mA), whereas a single-cell lithium battery delivers approximately 3.6 volts and two alkaline cells in series deliver approximately 3.0 volts. In this circumstance, a voltage  
30 converter is typically employed to boost the voltage to a level suitable for supplying the LED.

[0004] One example of a known integrated circuit boost converter IC1 is given in Figure 1. In this example, the boost converter IC1 may be a type RYC 9901 high-power multi-LED boost converter supplied by Tyco Electronics Corporation, the assignee of the present  
35 invention, or equivalent. This circuit IC1 may be operated from a battery B comprising a single lithium cell or two alkaline cells in series, and is capable of driving up to 8 LEDs in

series, two LEDs D1 and D2 being shown in Figure 1. In normal operation, IC1 operates as a discontinuous conduction mode non-isolated flyback converter.

5 [0005] When an NMOS transistor switch M1 is conducting, current from battery B flows into an external inductor L1 and a magnetic field develops. When the switch M1 is turned off, current flows out of the inductor, through an external Schottky diode SD1 and into a storage capacitor C2. When the storage capacitor C2 is charged, current at a higher voltage than supplied from the battery B passes through one or more series-connected light emitting diodes D1, D2 and a current sense resistor R1 providing a feedback control signal to IC1. An  
10 input filter capacitor C1 may be provided. As shown in Figure 1, IC1 may also include internal elements including amplifiers U1 and U2, AND gate G1, latch LA1 and an internal current sense resistor R2, connected as shown.

15 [0006] Another known way to generate constant current for a load, such as an LED, is to employ a charge pump circuit topology. For example, a type MAX684 voltage regulated charge pump, supplied by Maxim Integrated Products, Inc., Sunnyvale, California, can power three or more white color LEDs. The MAX684 charge pump regulator generates 5 volts from a 2.7V to 4.2V input, but requires a ballast resistor or current source for each LED as well as external capacitors. The ballast resistors lower the efficiency of the driver by the large  
20 voltage drop needed. In order to control brightness, Maxim suggests that an external switching transistor controlled by a PWM brightness control be employed.

[0007] With reference to Figure 2A, a single charge pump voltage doubler/inverter representative of the prior art is shown. A DC voltage applied across terminals 1 and 2  
25 becomes stored in an input charge store, such as capacitor Ci. When switches S1 and S2 are closed, the charge is transferred from input capacitor Ci to a so-called "flying" capacitor Cf in accordance with a current flow Ia. Switches S1 and S2 are opened, and a potential now appears across the flying capacitor Cf. Then, switches S3 and S4 are closed, and the charge across the flying capacitor Cf is transferred to an output charge store, such as capacitor Co.  
30 Switches S3 and S4 are opened, and the charge across the output store Co is available to be supplied to a load. It is important to the proper operation of the charge pump shown in Figure 2A that the switch pairs S1-S2 and S3-S4 are closed during non-overlapping clock intervals. Accordingly, a clock circuit generates a first switch phase PHI 1 (applied to control S1 and S2) and a second, non-overlapping switch phase PHI 2 (applied to control S3 and S4) as  
35 shown in Figure 2B. (In practice actual clock non-overlap is less than as graphed in Figure 2B.) If terminal 4 is connected to terminal 1, a voltage doubler results. If terminal 3 is connected to terminal 2, a voltage inverter results. When the switches S1, S2, S3 and S4 are

true MOS switches, they permit current to flow in either direction when closed, thereby allowing energy transfer from output to input as well as from input to output. While this prior topology has worked satisfactorily, like the Figure 1 inductor-based solution, the prior charge pump solution has typically required an external sense resistor to regulate and maintain a constant current flow through the external load.

[0008] A hitherto unsolved need has arisen to provide a single, integrated circuit driver which uses a charge pump topology in which magnitude of output current to a load is adjusted by the scaling of capacitance of a single external flying capacitor and maintained at the scaled level, in a manner overcoming limitations and drawbacks of the prior art.

### BRIEF SUMMARY OF THE INVENTION

[0009] A general object of the present invention is to provide an electronic circuit for driving a load with a constant current irrespective of variations in supply voltage within a supply voltage range.

[0010] Another object of the present invention is to provide an electronic circuit comprising a current regulated charge pump wherein magnitude of output current is established by selecting the value of an external flying capacitor.

[0011] Yet another object of the present invention is to provide an electronic driver circuit for delivering a constant output current over a range of input voltage, based upon a dual charge pump circuit topology enabling comparison of a model charge pump current set by an internal flying capacitor with output current put out by a primary charge pump, such that regulated output current is set by selecting the value of an external flying capacitor within the primary charge pump circuit arrangement.

[0012] Still one more object of the present invention is to provide a low-cost, high frequency charge pump integrated circuit for driving one to four super-bright LEDs, for example, with a constant current over an input voltage range usually present with battery power supplies and without need for any external current sense resistor.

[0013] Yet one more object of the present invention is to provide a low-cost six-pin current regulated charge pump driver IC with external enable and user settable regulated drive current, which can be fabricated using known low-cost CMOS IC processes.

[0014] As one aspect of the present invention, an electrical system is provided for regulating electrical current flowing from a power source to a load. In this particular aspect, the electrical system includes the following interconnected structural elements. A current pass regulator element is connectable to the power source and functions to control supply current drawn from the power source. A primary voltage multiplying finite output resistance circuit has an input connected to the current pass regulator element and an output connectable to the load. The primary voltage multiplying finite output resistance circuit includes a user settable output resistance determining element for determining magnitude of output resistance. In a preferred embodiment, the current determining element comprises a flying capacitor within a primary charge pump circuit. A model voltage multiplying finite output resistance circuit includes an input connected to the current pass regulator element and provides an output to a current sense circuit that supplies an output current equal to model voltage multiplying circuit output current ( $I_{model}$ ). A constant current source sinking a reference current ( $I_{ref}$ ) is connected to the current sense output. The current sense circuit forces the output of the model voltage multiplying circuit to be equal to the primary voltage multiplying circuit output. Thus, both the primary and model voltage multiplying circuits enjoy the same terminal voltages, or operating point. Therefore, the ratio of the primary voltage multiplying circuit output current to the model voltage multiplying circuit output current is fixed by the multiplying circuit designs, and not by the terminal voltages. In a preferred embodiment, this ratio is established as a ratio between capacitance of an internal capacitor to capacitance of an external capacitor. A control circuit controls the current pass regulator element to force the current  $I_{model}$  to be equal to the reference current  $I_{ref}$ . In this manner current passing through the primary voltage multiplying finite output resistance circuit is regulated at a level established by the user settable current determining element irrespective of input voltage variation of the power source. A related aspect of the present invention provides an integrated circuit for regulating electrical current flowing from a battery power source to a load without requiring an external or internal current sense resistor. This related aspect is realized by using a model charge pump that "mirrors" the primary charge pump to generate a scaled copy of the output current. The two charge pumps are controlled in unison, so that the scaled model current is fixed by an internal current reference. Thus, the primary charge pump output current is stabilized without any sense resistor.

[0015] As a further aspect of the present invention, a method is provided for regulating current flowing from a battery to a load without directly sensing current flow at the load. In this aspect of the present invention, the method includes the following steps:

(a) passing current from the battery through a current pass regulator element,

(b) providing current from the current pass regulator element to a primary voltage multiplying finite output resistance circuit providing current flow to the load,

5 (c) selecting a value for a user settable output resistance determining element of the primary voltage multiplying finite output resistance circuit in order to determine magnitude of regulated current to flow to the load,

(d) providing current from the current pass regulator element to a model voltage multiplying finite output resistance circuit in order to generate a model current  
10  $I_{model}$ ,

(e) passing the model current through a current sense element, and into a constant current source for sinking a reference current  $I_{ref}$ , and

(f) controlling the current pass regulator element to force the current  
15  $I_{model}$  to be equal to the reference current  $I_{ref}$ , such that current passing through the primary voltage multiplying finite output resistance circuit is regulated at a level established by the user settable current determining element irrespective of input voltage variation of the power source.

[0016] These and other objects, advantages, aspects and features of the present invention  
20 will be more fully understood and appreciated upon consideration of the detailed description of preferred embodiments presented in conjunction with the following drawings.

#### BRIEF DESCRIPTION OF THE DRAWINGS

25 [0017] Figure 1 is a block and schematic circuit diagram of a conventional integrated circuit boost converter for driving a load to a current level monitored by an external resistor and feedback connection.

[0018] Figure 2A is a simplified schematic circuit diagram of a capacitor-based charge  
30 pump known in the prior art.

[0019] Figure 2B is a graph of two-phase clock waveforms drawn along a common horizontal time base.

35 [0020] Figure 3 is a block and schematic circuit diagram of an integrated circuit forming a charge pump driver for a load in accordance with principles of the present invention.

[0021] Figure 4 is a more detailed diagram illustrating the primary charge pump architecture and clock included within the Figure 3 block and schematic circuit diagram.

[0022] Figure 5 is a greatly enlarged top plan view of a miniature surface-mount integrated circuit package including the Figure 3 IC circuitry in accordance with principles of the present invention.

#### DETAILED DESCRIPTION OF THE INVENTION

10 [0023] In accordance with principles of the present invention, and as shown in the circuit of Figure 3, an integrated circuit 10 implements a current regulated charge pump wherein the magnitude of output current is adjustable by scaling of the capacitance value of a single external flying capacitor  $C_p$ . The IC 10 includes two charge pumps, namely a primary charge pump 12 and a model charge pump 14. While the primary charge pump 12 may have any  
15 switching topology, it most preferably is in accordance with the Figure 4 arrangement, having internal connections to form a voltage doubler. While the circuit topology must be the same for both the primary charge pump 12 and the model charge pump 14, the actual circuit layouts may be scaled so long as the primary charge pump 12 operates proportionally with respect to the model charge pump 14, with the nominal current put out by the primary charge pump 12  
20 being set by a user-selected, externally connected flying capacitor  $C_p$ . By making the primary charge pump 12 electrically proportional to the model charge pump 14, the model charge pump 14 can be operated at far less current than that used and sourced by the primary charge pump 12, and take up far less integrated circuit die area.

25 [0024] The primary charge pump 12 utilizes the externally connected capacitor  $C_p$  as its flying capacitor, whereas the model charge pump 14 utilizes an internal capacitor  $C_m$  formed on the integrated circuit chip as its flying capacitor. The primary charge pump 12 has an output  $V_1$  that forms the OUT path for the IC 10. The model charge pump 14 has an output  $V_2$ . A voltage amplifier U3 (having finite gain) subtracts the  $V_2$  output from the  $V_1$  output  
30 to provide a difference voltage. The circuit U3 may be implemented in a variety of manners including, but not limited to, an operational amplifier or a PMOS differential pair. The difference voltage put out by U3 is applied to a control gate electrode of a PMOS transistor M2. The PMOS transistor M2 is connected in series between the model charge pump output  $V_2$  and a constant current source 16 that sinks a constant current  $I_{ref}$  to ground. The circuit  
35 elements U3 and M2 form a current sense circuit that forces  $V_2$  to be approximately the same as the output voltage on OUT. The current required to achieve this is  $I_{model}$ , the output current from the model charge pump 14.

[0025] A series pass regulator element, represented in the Figure 3 block diagram as a PMOS transistor M3, is provided to adjust the input drive level from a DC supply 18, such as a lithium battery, to the primary charge pump 12 and the model charge pump 14. An input capacitor C3 minimizes voltage drops at the input of the IC 10 in response to high frequency switching operations occurring within the charge pumps 12 and 14. An output capacitor C4 acts to filter out any switching transients otherwise remaining in the output current supplied by IC 10.

[0026] A current controlled voltage source U4 has an input connected to a node between the drain electrode of PMOS transistor M2 and the constant current source 16, and has an output connected to a gate control electrode of the pass element PMOS transistor M3. The circuit U4 functions as a current-to-voltage converter and generates a voltage control as a function of current imbalance between  $I_{model}$  and  $I_{ref}$  sensed at its input. The voltage control is applied to a control gate electrode of the pass element M3 such that the current  $I_{model}$  passing through the PMOS transistor M2 is forced to remain equal to the internal fixed reference current  $I_{ref}$  generated by constant current source 16. If  $I_{model}$  is greater than  $I_{ref}$ , excess current present at the input of U4 is sunk to ground through U4 and the voltage control to M3 causes input current to be reduced. If  $I_{model}$  is less than  $I_{ref}$ , additional current is sourced by U4 to the constant current source 16 and the voltage control to M3 causes input current to the charge pumps to be increased. This regulation process operates automatically to maintain  $I_{model}$  equal to  $I_{ref}$ .

[0027] The integrated circuit 10 includes an internal clock element 20 which generates the non-overlapping switching signals  $\Phi 1$  (i.e.  $\Phi 1$ ) and  $\Phi 2$  (i.e.  $\Phi 2$ ) shown in Figure 2B at a suitable clock frequency, such as 1.2 MHz for example, and applies them simultaneously to control the primary charge pump 12 and the model charge pump 14. A true logical level at the enable pin EN of IC 10 enables the circuitry to generate and put out regulated current  $I_{out}$  to a load 22. The load may be any desired load, particularly but not necessarily one or more super-bright LEDs. A low frequency pulse width modulator (PWM) signal applied to the enable pin EN turns the IC 10 on and off, thereby modulating the output current and dimming the LED light level, for example. For example, applying a 1 KHz PWM signal with a duty cycle of 700 microseconds results in a light level which is 70% of the maximum drive level set by the external switched capacitor  $C_p$ .

[0028] Multiple LEDs may be connected in series or in parallel. If connected in parallel, current equalization series resistors or ballast resistors may be utilized to balance current



flows and light outputs of the multiple LEDs, given a range of manufacturing tolerances. If several super-bright LEDs are to be driven, output light level matching considerations may require small ballast resistors. These resistors can typically be smaller and more efficient than the fixed output voltage design techniques employed in the prior art discussed hereinabove.

5 For example, Figure 5 shows four super-bright LEDs D10, D11, D12, and D13, each LED having a series current equalization resistor R10, R11, R12 and R13 selected to make light output of diodes D1-D4 uniform.

[0029] Since the input voltage Vreg output by the pass element PMOS transistor M3 is  
10 common to both the primary charge pump 12 and the model charge pump 14, and the output voltages of both charge pumps are forced to be equal, the output current produced by the model charge pump 14 is a scaled replica of the output current produced by the primary charge pump 12. The output current Iout can be expressed as follows:

$$15 \quad I_{out} = \frac{C_p}{C_m} I_{model}$$

[0030] Since the circuit U4 forces the current Imodel to be equal to the reference current  
20 Iref, the output current can be expressed as follows:

$$I_{out} = \frac{C_p}{C_m} I_{ref} = C_p K$$

25 [0031] Since the constant K is fixed by appropriate design of the integrated circuit 10, the regulated output current Iout can be scaled by selecting the capacitance value of the external flying capacitor Cp. In normal operation, the IC 10 delivers a constant current to the load, regardless of actual input voltage within an operational range.

30 [0032] For example, over an input voltage range of 1.6 to 3.4 volts, a 100 nanofarad (nF) capacitor Cp results in approximately 30 mA of output current, a 47 nF capacitor Cp results in approximately 20 mA of output current, a 22 nF capacitor results in approximately 15 mA of output current, and a 10 nF capacitor results in approximately 5 mA of output current, from  
35 IC 10. With a switching frequency of 1.2 MHz, full current is reached in approximately four microseconds from first assertion of the enable signal.

[0033] IC 10 is most preferably fabricated using known low-cost CMOS IC processes. As shown in Figure 5, IC 10 may be contained in a small package having only six external pins: Cp1 (pin 1), ground (pin 2), enable (pin 3), Vin (pin 4), OUT (pin 5) and Cp2 (pin 6). Preferably, although not necessarily, the package may comprise an industry standard surface-mount SOT-23-6 package having a nominal length of 3.0 mm, a width (exclusive of pins) of 1.67 mm and a height of 1.35 mm, for example. With the arrangement shown, there is no need for, nor provision for, any external sense resistor or pin therefor.

[0034] Thus, it will be appreciated that the present invention provides a charge pump based driver integrated circuit 10 providing constant current regulation, user settable by selection of an external flying capacitance value, with a wide current range extending to 100 mA, or more. The circuit 10 operates with a wide input voltage range, for example 1.6 volts to 5.0 volts. When non-enabled in shutdown mode, the circuit 10 draws as little as 2  $\mu$ A. The circuit 10 enable may be pulse width modulated so as to provide a ten to one linear dimming range for LEDs. Applications for the integrated circuit 10 include, but are clearly not limited to, driving super-bright LED flashlights, battery-powered indicator lights, cell phone display panel back lighting, keyless entry systems, wireless security systems, automatic meter readers, etc.

[0035] Having thus described a preferred embodiment of the invention, it will now be appreciated that the objects of the invention have been fully achieved, and it will be understood by those skilled in the art that many changes in construction and widely differing embodiments and applications of the invention will suggest themselves without departing from the spirit and scope of the invention. Therefore, the disclosures and descriptions herein are purely illustrative and are not intended to be in any sense limiting.